

ABSTRACT OF THE DISCLOSURE

An electronic device. A host is equipped with a circuit including a first and second heat source. A heat-dissipating module has a conductive assembly disposed on the first heat source and a first fan assembly located between a surroundings and the conductive assembly. As an initial airflow of the surroundings passes the first heat source, its temperature increases, but is lower than the second heat source. As the airflow passes the second heat source, temperature increases again, and is then expelled to the exterior of the host.